

General Description

The HSL2P25 is the high cell density trench P-ch MOSFETs, which provides excellent RDSON and efficiency for most of the small power switching and load switch applications. The HSL2P25 meets the RoHS and Green Product requirement with full function reliability approved.

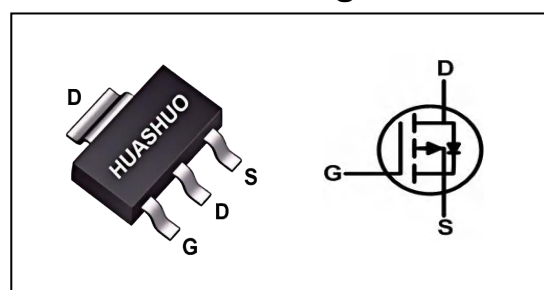
Features

- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available
- Advanced high cell density Trench Technology

Product Summary

V_{DS}	-250	V
$R_{DS(ON),Max}$	4	Ω
I_D	-2	A

SOT-223 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-250	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ -10V ¹	-2.0	A
$I_D@T_C=70^\circ C$	Continuous Drain Current, V_{GS} @ -10V ¹	-1.0	A
$I_D@T_A=25^\circ C$	Continuous Drain Current, V_{GS} @ -10V ¹	-0.4	A
$I_D@T_A=70^\circ C$	Continuous Drain Current, V_{GS} @ -10V ¹	-0.3	A
I_{DM}	Pulsed Drain Current ²	-1.2	A
$P_D@T_A=25^\circ C$	Total Power Dissipation ³	1.3	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹	---	100	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	50	$^\circ C/W$

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=-250\mu A$	-250	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=-10V$, $I_D=-0.3A$	---	3.3	4	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=-250\mu A$	-2.0	-3.0	-4.0	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=-200V$, $V_{GS}=0V$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=-200V$, $V_{GS}=0V$, $T_J=55^\circ\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=-5V$, $I_D=-0.8A$	---	1.5	---	S
Q_g	Total Gate Charge	$V_{DS}=-100V$, $V_{GS}=-4.5V$, $I_D=-0.3A$	---	8.9	---	nC
Q_{gs}	Gate-Source Charge		---	1.5	---	
Q_{gd}	Gate-Drain Charge		---	1.8	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=-100V$, $V_{GS}=-10V$, $R_G=6\Omega$ $I_D=-0.3A$	---	1.9	---	ns
T_r	Rise Time		---	1.6	---	
$T_{d(off)}$	Turn-Off Delay Time		---	22	---	
T_f	Fall Time		---	10.5	---	
C_{iss}	Input Capacitance	$V_{DS}=-100V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	500	---	pF
C_{oss}	Output Capacitance		---	39	---	
C_{rss}	Reverse Transfer Capacitance		---	20	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current ^{1,4}	$V_G=V_D=0V$, Force Current	---	---	-0.4	A
I_{SM}	Pulsed Source Current ^{2,4}		---	---	-1.2	A
V_{SD}	Diode Forward Voltage ²	$V_{GS}=0V$, $I_S=-1A$, $T_J=25^\circ\text{C}$	---	---	-1.3	V

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3.The power dissipation is limited by 150°C junction temperature
- 4.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

Figure 1. Output Characteristics

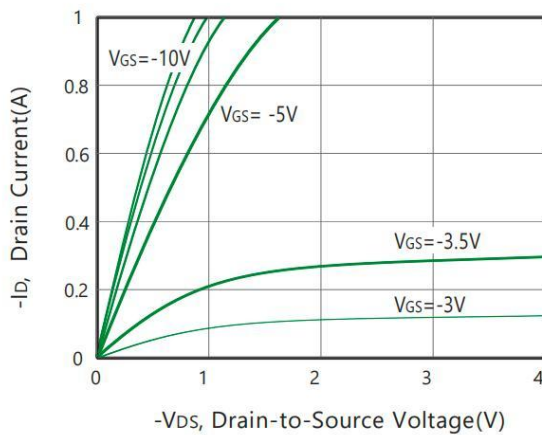


Figure 2. Body Diode Forward Voltage Variation with Source Current

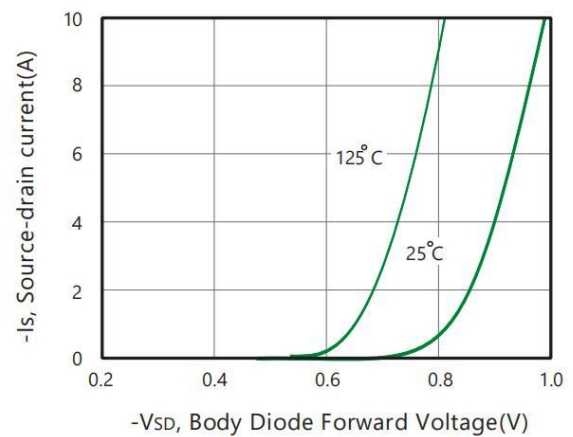


Figure 3. On-Resistance vs. Gate-Source Voltage

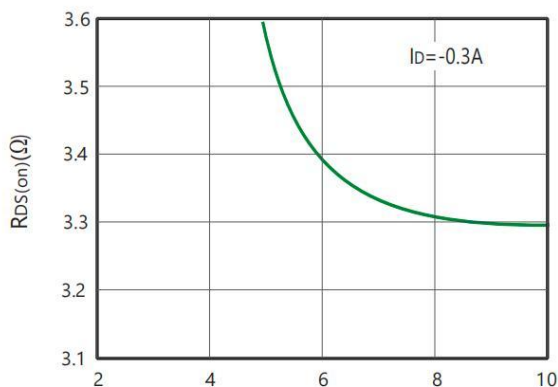


Figure 4. On-Resistance Variation with Drain Current and Temperature

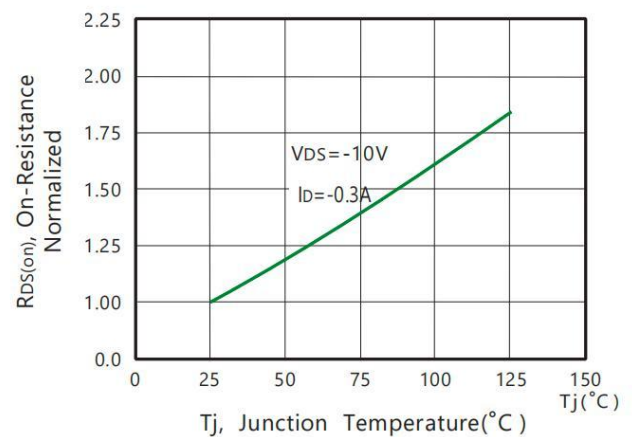


Figure 5. Gate Threshold Variation with Temperature

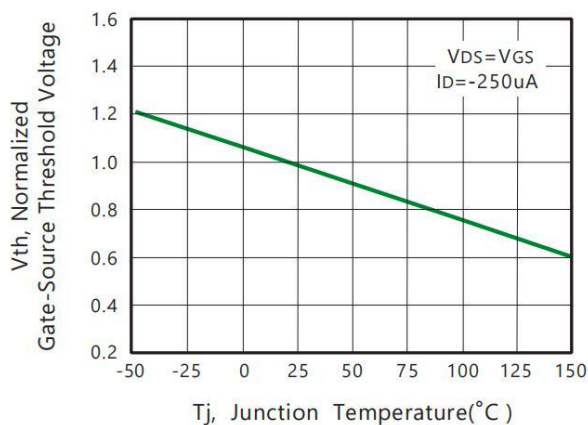


Figure 6. Gate Charge

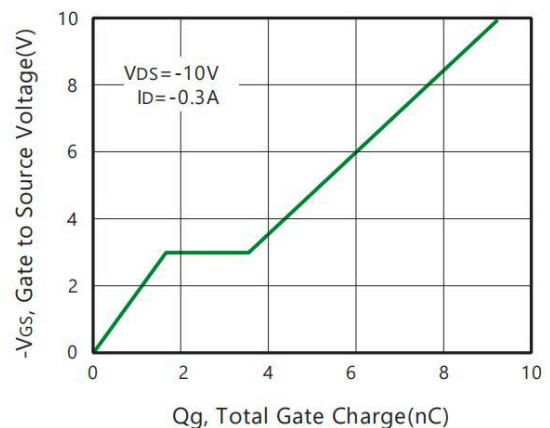




Figure 7. Capacitance

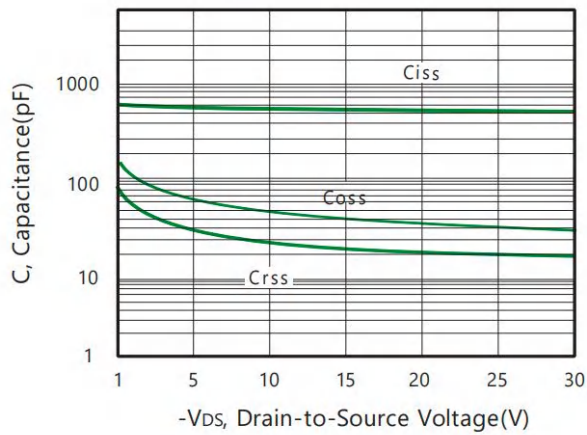


Figure 8. Maximum Safe Operating Area

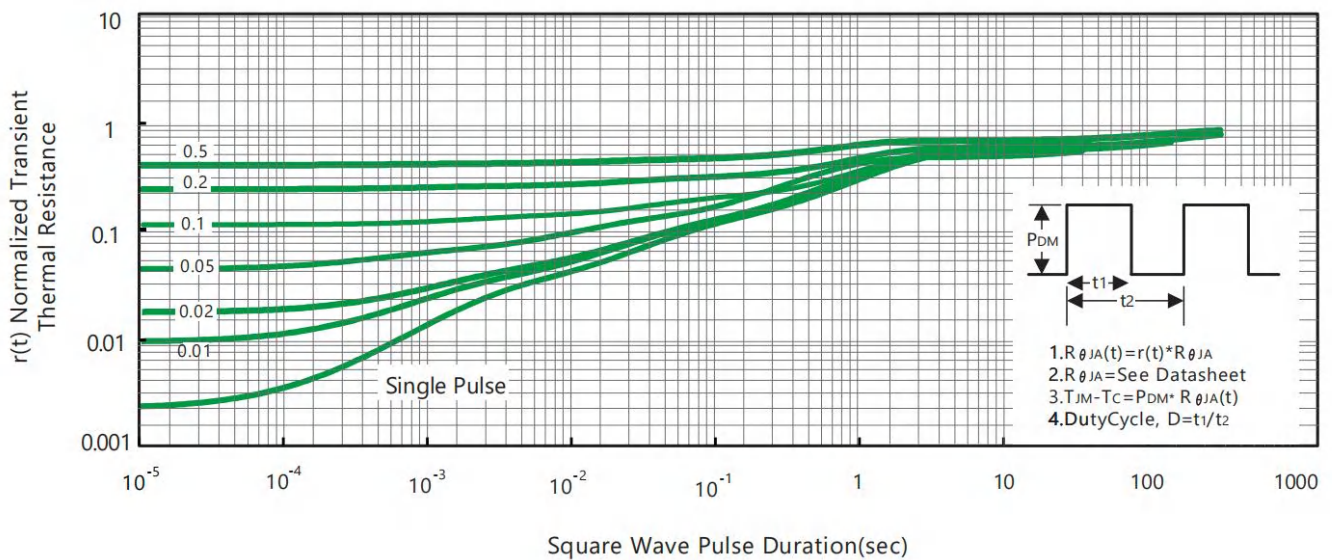
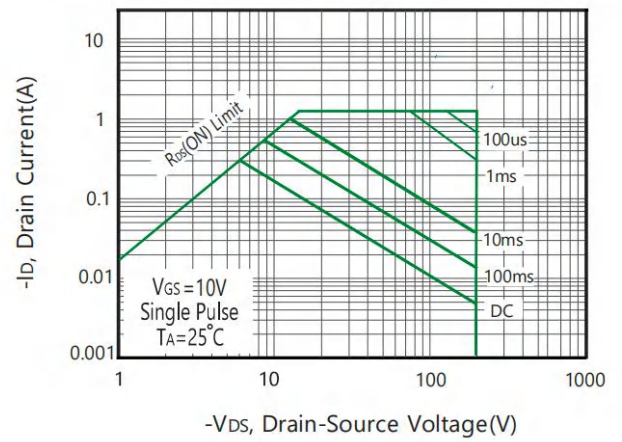
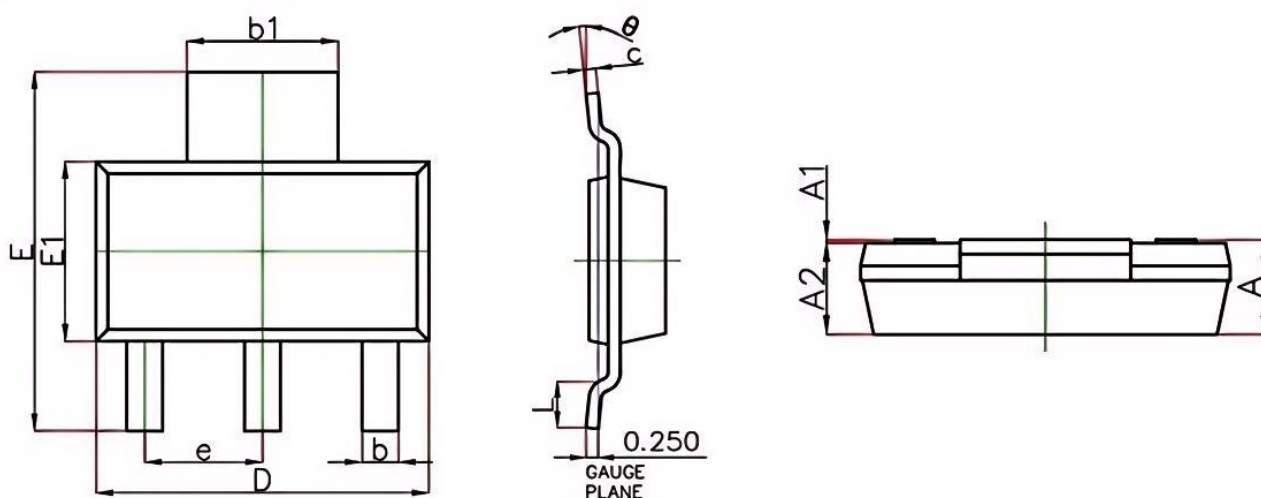


Figure 9. Normalized Thermal Transient Impedance Curve

Ordering Information

Part Number	Package code	Packaging
HSL2P25	SOT-223	3000/Tape&Reel

SOT-223 Package Outline



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	-	1.800	-	0.071
A1	0.020	0.100	0.001	0.004
A2	1.450	1.750	0.057	0.069
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
C	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300(BSC)		0.091(BSC)	
L	0.750	-	0.030	-
θ	0°	10°	0°	10°

HSL2P25 Marking:

